

## 74LVX3L384 10-Bit Low Power Bus Switch

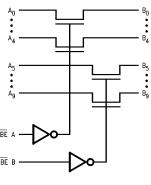
### **General Description**

The LVX3L384 provides 10 bits of high-speed CMOS TTL-compatible bus switches. The low on resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise. The device is organized as two 5-bit switches with separate bus enable ( $\overline{\text{BE}}$ ) signals. When  $\overline{\text{BE}}$  is low, the switch is on and port A is connected to port B. When  $\overline{\text{BE}}$  is high, the switch is open and a high-impedance state exists between the two ports.

### **Features**

- lacksquare 5 $\Omega$  switch connection between two ports
- Zero propagation delay
- Ultra low power with 0.2 µA typical I<sub>CC</sub>
- Zero ground bounce in flow-through mode
- Control inputs compatible with TTL level
- Available in SOIC, TSSOP and QSOP (SSOP 0.15" Body width)

### **Logic Diagram**



#### TL/F/11653-1

## **Connection Diagram**

## Pin Assignment for SOIC, QSOP and TSSOP



TL/F/11653-2

### **Truth Table**

BE A	BE B	B <sub>0</sub> -B <sub>4</sub>	B <sub>5</sub> -B <sub>9</sub>	Function	
L	L	A <sub>0</sub> -A <sub>4</sub>	A <sub>5</sub> -A <sub>9</sub>	Connect	
L	Н	A <sub>0</sub> -A <sub>4</sub>	HIGH-Z State	Connect	
Н	L	HIGH-Z State	A <sub>5</sub> -A <sub>9</sub>	Connect	
Н	Н	HIGH-Z State	HIGH-Z State	Disconnect	

Pin Names	Description
BE A, BE B	Bus Switch Enable
A <sub>0</sub> -A <sub>9</sub>	Bus A
B <sub>0</sub> -B <sub>9</sub>	Bus B

	SOIC JEDEC	QSOP	TSSOP
Order Number	74LVX3L384WM 74LVX3L384WMX	74LVX3L384QSC 74LVX3L384QSCX	74LVX3L384MTC 74LVX3L384MTCX
See NS Package Number	M24B	MQA24	MTC24

TRI-STATE® is a registered trademark of National Semiconductor Corporation.

### **Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

# Recommended Operating Conditions

Supply Voltage (V<sub>CC</sub>) 4.0V to 5.5V Free Air Operating Temperature ( $T_A$ )  $-40^{\circ}$ C to  $+85^{\circ}$ C

### **DC Electrical Characteristics**

			$74LVX3L384$ $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$					
Symbol	Parameter	v <sub>cc</sub>				Units	Conditions	
		(V)	Min	Typ (Note 5)	Max		Oshallons	
V <sub>IK</sub>	Maximum Clamp Diode Voltage	4.75			-1.2	V	$I_{\text{IN}} = -18 \text{ mA}$	
V <sub>IH</sub>	Minimum High Level Input Voltage	4.75–5.25	2.0			V		
V <sub>IL</sub>	Maximum Low Level Input Voltage	4.75-5.25			0.8	V		
I <sub>IN</sub>	Maximum Input	0			10		$0 \le V_{IN} \le 5.25V$	
	Leakage Current	5.25			± 1	μΑ		
l <sub>OZ</sub>	Maximum TRI-STATE® I/O Leakage	5.25			±10	μΑ	$0 \le A, B \le V_{CC}$	
los	Short Circuit Current	4.75	100			mA	$V_{I}(A), V_{I}(B) = 0V,$ $V_{I}(B), V_{I}(A) = 4.75V$	
R <sub>ON</sub>	Switch On	4.75		5	7	Ω	$V_{I} = 0V, I_{ON} = 30 \text{ mA}$	
	Resistance (Note 3)	4.75		10	15	Ω	$V_{I} = 2.4V, I_{ON} = 15 \text{ mA}$	
Icc	Maximum Quiescent Supply Current	5.25		0.2	10	μΑ	$V_{I} = V_{CC}$ , GND $I_{O} = 0$	
ΔI <sub>CC</sub>	Increase in I <sub>CC</sub> per Input (Note 4)	5.25			2.5	mA	V <sub>IN</sub> = 3.15V, I <sub>O</sub> = 0 Per Control Input	

Note 3: Measured by voltage drop between A and B pin at indicated current through the switch. On resistance is determined by the lower of the voltages on the two (A or B) pins.

Note 4: Per TTL driven Input ( $V_{IN}=3.15V$ , control inputs only). A and B pins do not contribute to  $I_{CC}$ .

Note 5: All typical values are at  $V_{CC} = 5.0V$ ,  $T_A = 25^{\circ}C$ .

### **AC Electrical Characteristics:**

Symbol	Parameter	۷ <sub>0</sub> 0 ا	$74LVX3L384 \\ T_A = -40^{\circ}C \text{ to } +85^{\circ}C \\ C_L = 50 \text{ pF}$			Units
			Min	Typ (Note 5)	Max	
T <sub>PLH</sub> T <sub>PHL</sub>	Data Propagation Delay An to Bn or Bn to An (Note 6)	4.75			0.25	ns
T <sub>PZL</sub> T <sub>PZH</sub>	Switch Enable Time BE <sub>A</sub> , BE <sub>B</sub> to An, Bn	4.75	1.5		6.5	ns
T <sub>PLZ</sub> T <sub>PHZ</sub>	Switch Disable Time BE <sub>A</sub> , BE <sub>B</sub> to An, Bn	4.75	1.5		5.5	ns

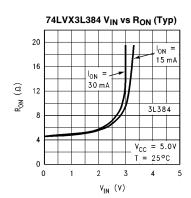
Note 5: All typical values are at  $V_{CC} = 5.0 V$ ,  $T_A = 25 ^{\circ} C$ .

Note 6: This parameter is guaranteed by design but not tested. The bus switch contributes no propagation delay other than the RC delay of the On resistance of the switch and the load capacitance. The time constant for the switch and alone is of the order of 0.25 ns for 50 pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

### Capacitance (Note)

Symbol	Parameter	Тур	Max	Units	Conditions
C <sub>IN</sub>	Control Input Capacitance	4	6	pF	$V_{CC} = 5.0V$
C <sub>I/O</sub> (OFF)	Input/Output Capacitance	9	13	pF	$V_{CC} = 5.0V$

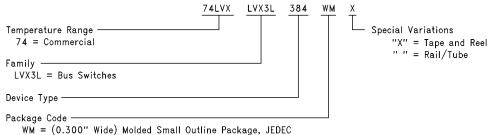
Note: Capacitance is characterized but not tested.



TL/F/11653-3

### 74LVX3L384 Ordering Information

The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:

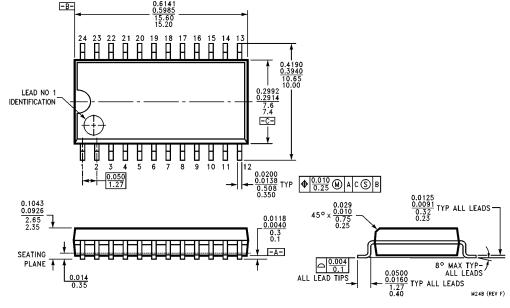


QSC = Shrink Small Outline Package, JEDEC (also known as QSOP)

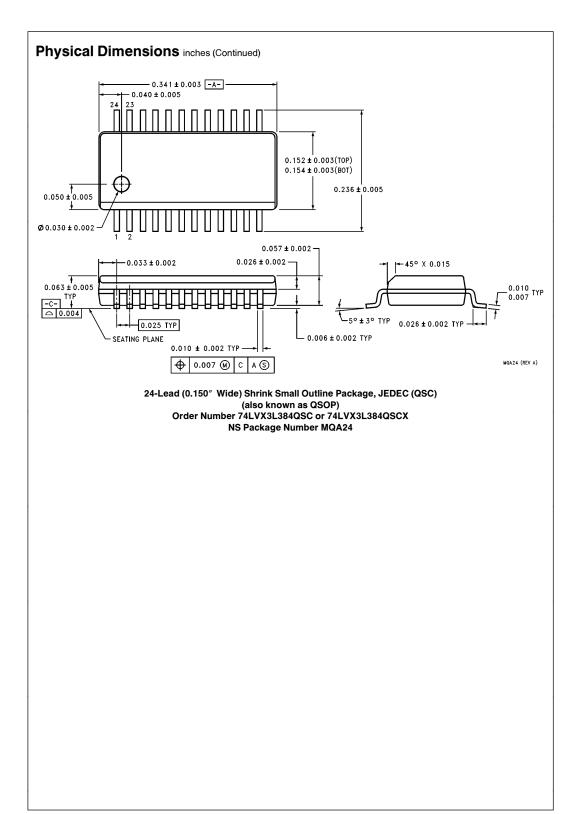
MTC = Thin Shrink Small Outline Package, JEDEC 4.4 mm Body Width

TL/F/11653-4

# Physical Dimensions $\frac{\text{inches}}{\text{millimeters}}$



24-Lead (0.300" Wide) Small Outline Package, JEDEC Order Number 74LVX3L384WM or 74LVX3L384WMX NS Package Number M24B



### Physical Dimensions inches (Continued) 4.16 -A-0.65 TYP LAND PATTERN RECOMMENDATION 6.4 0.25 4.4 ± 0.1 -B-3.2 SEATING PLANE 0.6 ± 0.1 DETAIL A △ 0.2 C B A TYPICAL SEE DETAIL D ALL LEAD TIPS (0.90)□ 0.1 C -c-0.65 TYP 0.09-0.20 TYP 0.10 ± 0.05 TYP 0.19 - 0.30 TYP $\oplus$ 0.13 M Α B (S) c (S MTC24 (REV B)

#### LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

24-Lead Thin Shrink Small Outline Package, JEDEC Order Number 74LVX3L384MTC or 74LVX3L384MTCX NS Package Number MTC24

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



National Semiconductor Corporation Americas Tel: 1(800) 272-9959

Americas Tel: 1(800) 272-9959 Fax: 1(800) 737-7018 Email: support@nsc.com

http://www.national.com

National Semiconductor Europe

Fax: +49 (0) 180-530 85 86 Email: europe.support@nsc.com
Deutsch Tel: +49 (0) 180-530 85 85 English Tel: +49 (0) 180-532 78 32
Français Tel: +49 (0) 180-532 95 85 Italiano Tel: +49 (0) 180-534 16 80

National Semiconductor Southeast Asia Fax: (852) 2376 3901 Email: sea.support@nsc.com National Semiconductor Japan Ltd. Tel: 81-3-5620-7561 Fax: 81-3-5620-6179

National does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and National reserves the right at any time without notice to change said circuitry and specifications